COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE | BOARD #: PMP10344 | REV: A | SUN REV: Not In VersionControl
--- | --- | --- | ---
IGNORE --> Top Overlay | | | 

PLOT NAME = Top Assembly Drawing | GENERATED : 10/22/2014 7:06:30 AM | TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE

BOARD #: PMP10344  
REV: A  
SUN REV: Not In Version Control

IGNORE ->  
Bottom Operation

PLOT NAME = Bottom Assembly Drawing

GENERATED : 10/22/2014 7:06:31 AM

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